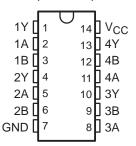
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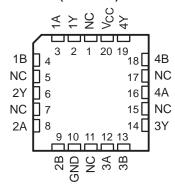
- Operating Voltage Range of 4.5 V to 5.5 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 20-μA Max I_{CC}

SN54HCT02...J OR W PACKAGE SN74HCT02...D, DB, N, NS, OR PW PACKAGE (TOP VIEW)



- Typical t_{pd} = 10 ns
- ±4-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Inputs Are TTL-Voltage Compatible

SN54HCT02 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

description/ordering information

These devices contain four independent 2-input NOR gates. They perform the Boolean function $Y = \overline{A} \bullet \overline{B}$ or $Y = \overline{A} + \overline{B}$ in positive logic.

ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 25	SN74HCT02N	SN74HCT02N
		Tube of 50	SN74HCT02D	
	SOIC - D	Reel of 2500	SN74HCT02DR	HCT02
		Reel of 250	SN74HCT02DT	
–40°C to 85°C	SOP - NS	Reel of 2000	SN74HCT02NSR	HCT02
	SSOP – DB	Reel of 2000	SN74HCT02DBR	HT02
		Tube of 90	SN74HCT02PW	
	TSSOP – PW	Reel of 2000	SN74HCT02PWR	HT02
		Reel of 250	SN74HCT02PWT	
	CDIP – J	Tube of 25	SNJ54HCT02J	SNJ54HCT02J
–55°C to 125°C	CFP – W	Tube of 150	SNJ54HCT02W	SNJ54HCT02W
	LCCC – FK	Tube of 55	SNJ54HCT02FK	SNJ54HCT02FK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
Α	В	Υ
Н	Х	L
Х	Н	L
L	L	Н

logic diagram, each gate (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		-0.5	V to 7 V
Input clamp current, I _{IK} (V _I < 0 or V _I > V _{CC}) (see	e Note 1)	:	±20 mA
Output clamp current, IOK (VO < 0 or VO > VCC	y) (see Note 1)	:	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})		:	±25 mA
Continuous current through V _{CC} or GND		:	±50 mA
Package thermal impedance, θ_{JA} (see Note 2):	D package	!	86°C/W
	DB package	!	96°C/W
	N package	/	80°C/W
	NS package		76°C/W
	PW package	1	13°C/W
Storage temperature range, T _{stg}		-65°C to	o 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		SI	SN54HCT02			SN74HCT02			
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	\$ 5.5	4.5	5	5.5	V
VIH	High-level input voltage	V _{CC} = 4.5 V to 5.5 V	2	Š	,/	2			V
V _{IL}	Low-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		77	0.8			0.8	V
٧ _I	Input voltage		0	1	VCC	0		VCC	V
٧o	Output voltage		0	2	VCC	0		VCC	V
Δt/Δν	Input transition rise/fall time		0~	5	500			500	ns
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		Vaa	Т	A = 25°C	;	SN54HCT02		SN74HCT02		UNIT
PARAMETER			vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
Vari	VI = VIH or VIL	I _{OH} = -20 μA	4.5 V	4.4	4.499		4.4		4.4		V
VOH	AI = AIH OL AIL	$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7	7	3.84		٧
Val	VI = VIH or VIL	I _{OL} = 20 μA	4.5 V		0.001	0.1		0.1		0.1	V
VOL	AI = AIH OL AIL	I _{OL} = 4 mA			0.17	0.26		0.4		0.33	l v
lį	$V_I = V_{CC}$ or 0		5.5 V		±0.1	±100	`	±1000		±1000	nA
Icc	$V_I = V_{CC}$ or 0,	I _O = 0	5.5 V			2	2	40		20	μΑ
ΔI _{CC} †	One input at 0.5 V one of the of the order inputs at 0 or		5.5 V		1.4	2.4	7040	3		2.9	mA
Ci			4.5 V to 5.5 V		3	10		10		10	pF

[†] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or VCC.

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

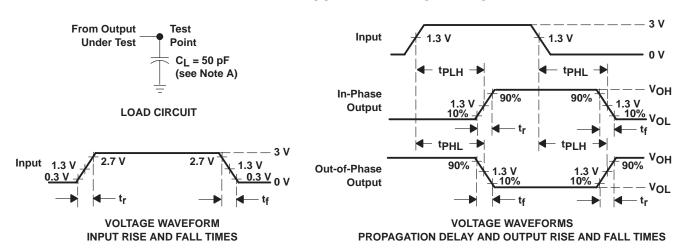
PARAMETER FROM TO		то		T,	ղ = 25°C	;	SN54HCT02	SN74HCT02	UNIT
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN MAX	MIN MAX	
	A == D	Y	4.5 V		11	20	30	25	
^t pd	A or B		5.5 V		10	18	27	22	ns
		V			9	15	22	19	
it		Ť	5.5 V		8	14	20	17	ns

operating characteristics, T_A = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	20	pF

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_r = 6$ ns, $t_f = 6$ ns.
- C. The outputs are measured one at a time with one input transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{Dd} .

Figure 1. Load Circuit and Voltage Waveforms



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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